

Synthesis of Wholly Alicyclic Polyimides from *N*-Silylated Alicyclic Diamines

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A synthetic method to give wholly aliphatic polyimides with high molecular weights has been developed. The polymerization of cyclobutanetetracarboxylic dianhydride (**CBDA**) with 5-trimethylsilylamino-*N*-trimethylsilyl-1,3,3-trimethylcyclohexanemethylamine (**NSD-1**) or 2,5(2,6)-bis(*N*-trimethylsilylaminoethyl)bicyclo[2.2.1]heptane (**NSD-2**) was carried out in polar aprotic solvents at room temperature, giving poly(amic acid trimethylsilyl ester)s (**PATSEs**) as precursor polymers which were hydrolyzed to poly(amic acid)s (**PAAs**) with inherent viscosities up to 0.74 dL g⁻¹. Both polyimide precursors were readily converted to the corresponding polyimides by thermal treatment.

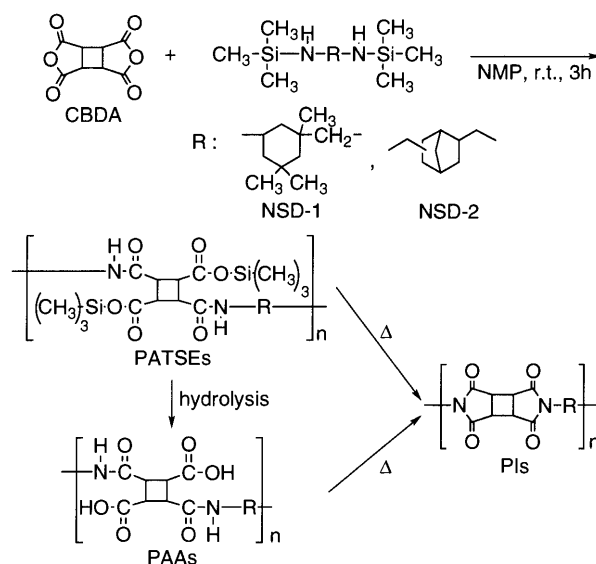
Polyimides (**PIs**) are widely used in microelectronics packaging as buffer coats, α -ray shielding and passivation films, because of their excellent thermal, chemical, mechanical and electrical properties.¹ Recently, aliphatic and alicyclic **PIs** have been interested in the applications as optoelectronics and inter-layer dielectric materials, because of the better colorless transparency and the low dielectric constant.^{2,3} They hardly form inter- or intramolecular charge transfer complexes, which increase the dielectric constant and lower the transparency. Furthermore, alicyclic structures are effective to decrease a molecular density due to their bulkiness, giving **PIs** with a low dielectric constant.

Generally speaking, the reaction of dicarboxylic anhydrides with highly basic diamines such as aliphatic and alicyclic diamines first provides an amic acid and then a free amine forms a carboxylic acid salt with carboxyl group of amic acid due to its high basicity. In the polymerization, the salt formation inhibits the formation of high molecular weight **PAA**. Sometimes, solution imidization and acid-chloride methods are available as previously reported.^{4,5} Furthermore, we reported the synthesis of **PIs** from *N*-silylated aromatic diamines and aromatic tetracarboxylic dianhydrides.⁶ For extension of this work, we were interested in this method for a synthesis of wholly alicyclic **PIs**.

In this paper, we describe the successful synthesis of wholly alicyclic **PIs** with relatively high molecular weights by the polymerization of **CBDA** with *N*-silylated alicyclic diamines.

As alicyclic diamines, 5-amino-1,3,3-trimethylcyclohexanemethylamine and 2,5(2,6)-bis(aminomethyl)bicyclo[2.2.1]heptane were selected and silylated with trimethylsilyl chloride in the presence of triethylamine in toluene.

The ring-opening polyaddition of **CBDA** with *N*-silylated diamines, **NSD-1** and **NSD-2** was carried out in various solvents at room temperature for 3 h (Scheme 1). Polymerizations proceeded in homogeneous state without salt formation, giving poly(amic acid trimethylsilyl ester)s (**PATSEs**), which were converted to the corresponding **PAAs** by hydrolysis. The inher-



Scheme 1. Synthesis of Wholly Alicyclic Polyimides from *N*-Silylated Alicyclic Diamines

Table 1. Synthesis of wholly alicyclic poly(amic-acid) (**PAA**)^a

Polymer	Diamine	Solvent	Yield	Inherent viscosity ^b
			%	dL g ⁻¹
PAA-1	NSD-1	NMP	100	0.73
PAA-2	NSD-2	NMP	91	0.58
PAA-3	NSD-1	DMAc	94	0.74
PAA-4	NSD-2	DMAc	84	0.46
PAA-5	NSD-1	DMSO	98	0.53
PAA-6	NSD-2	DMSO	84	0.50
PAA-7	NSD-1	THF	97	0.39
PAA-8	NSD-2	THF	67	0.30

^aPolymerization was carried out with 1.0 mmol of each monomer (**CBDA** and diamine) in the solvent at room temperature for 3 h under nitrogen. Monomer concentration: 30 wt%. ^bMeasured at a concentration of 0.5 g dL⁻¹ in NMP at 30 °C.

ent viscosities of **PAAs** obtained reached up to 0.74 dL g⁻¹. These results are summarized in Table 1.

Polymers were confirmed to be the corresponding **PATSEs** and **PAAs** by IR spectroscopy and elemental analysis. The IR spectra of **PATSEs** showed characteristic amide and silyl ester absorptions at 1654 and 1716 cm⁻¹. On the other hand, two characteristic amide, carboxyl, and hydroxyl group absorptions at 1654, 1720, and 3200-3700 cm⁻¹, were observed for **PAAs** (Figure 1). **PATSEs** were soluble in tetrahydrofuran (**THF**),

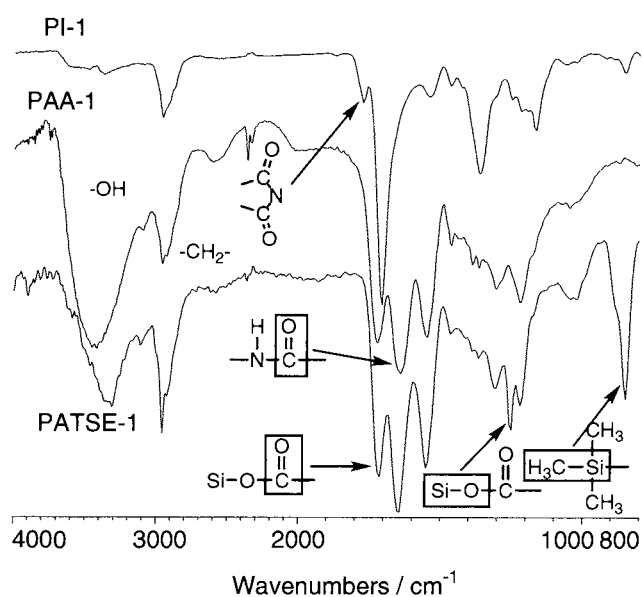


Figure 1. Change of IR spectra in PATSE-1, PAA-1 and PI-1 films.

chloroform, and polar aprotic solvents such as 1-methyl-2-pyrrolidinone (NMP), *N,N*-dimethylacetamide (DMAc) and dimethyl sulfoxide (DMSO) at room temperature. On the other hand, PAAs were only soluble in polar aprotic solvents.

These polyimide precursors were readily converted to the corresponding PIs by thermal treatment. The traces of thermogravimetric analysis for PAA-1 and the corresponding polyimide (PI-1) are shown in Figure 2. The rapid weight loss for PAA-1 was observed at 200–350 °C. In this range, the weight loss was 9.6% which is in good agreement with the value of weight loss (9.8%) calculated from the elimination of water due to the imidization. A 10% weight loss in nitrogen for PI-1 was 420 °C. This result shows the thermal stability is lower than that of aromatic PIs, whereas it is enough for microelectronics uses.

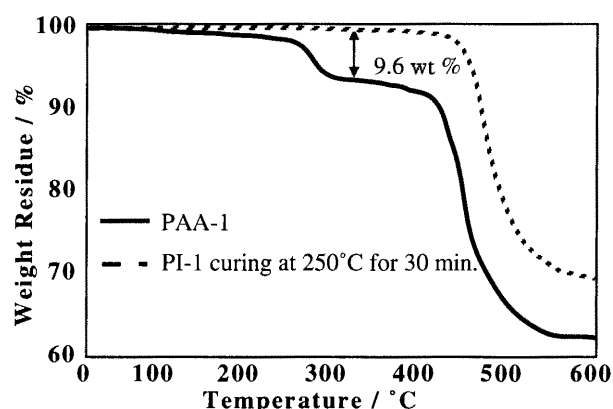


Figure 2. TG traces of PAA-1 and PI-1 under nitrogen.

The IR spectrum of thermally treated PAA-1 film (250 °C for 30 min), is shown in Figure 1. Where characteristic imide absorptions at 1780 and 1720 cm^{-1} were appeared and the absorption due to the carboxylic acid groups at around 3300 cm^{-1} was completely disappeared. The solubility of alicyclic PIs were low and they were only soluble in *m*-cresol and sulfuric acid.

In summary, the wholly alicyclic PIs were successfully prepared by *N*-silylated diamine method. This method will provide a potentially efficient route for the synthesis of aliphatic PIs.

References and Notes

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